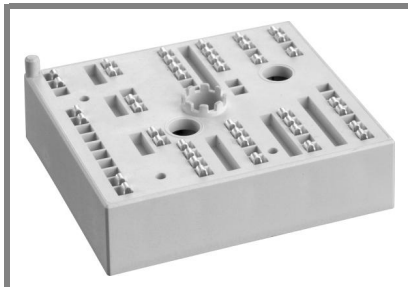


# SKiIP 28GH066V1



MiniSKiIP<sup>®</sup> 2

## H-bridge inverter

SKiIP 28GH066V1

### Features

- Trench IGBTs
- Robust and soft freewheeling diode in CAL technology
- Highly reliable spring contacts for electrical connection
- UL recognised file no. E63532

### Typical Applications\*

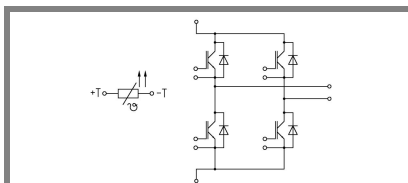
- Single-phase inverter up to 16 kVA
- Single-phase motor power 7.5 kW

### Remarks

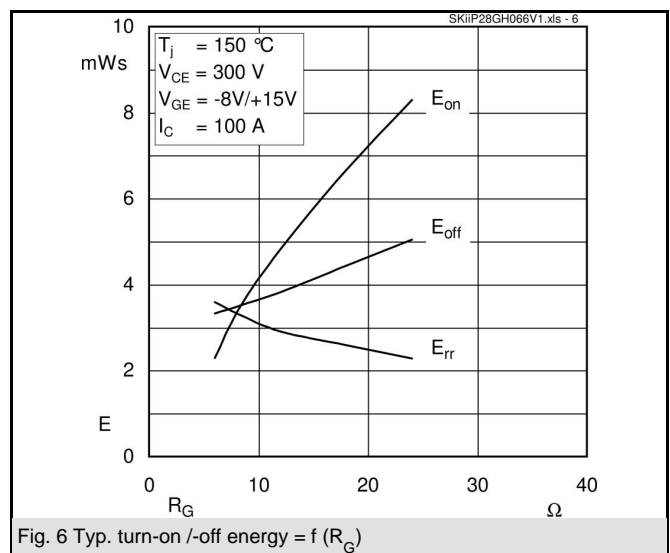
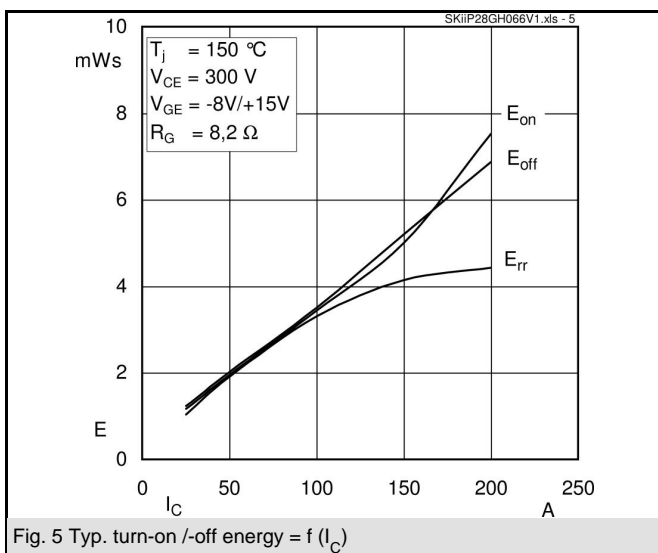
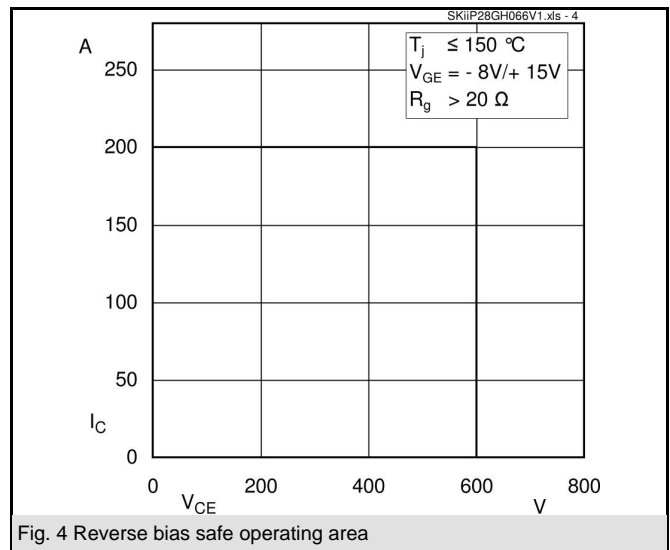
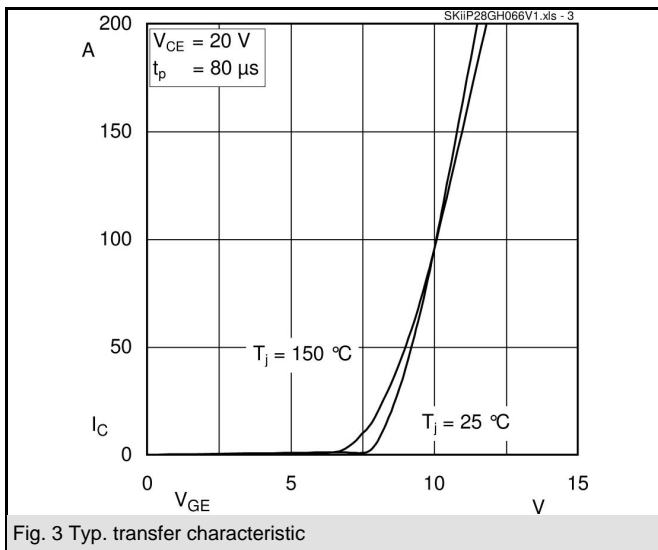
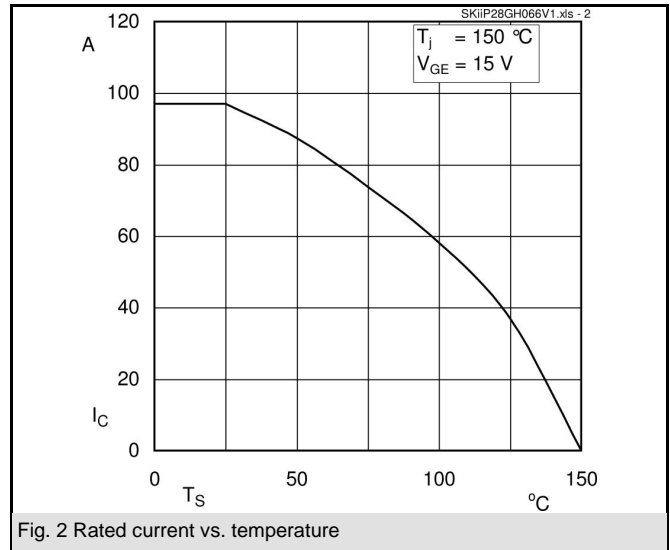
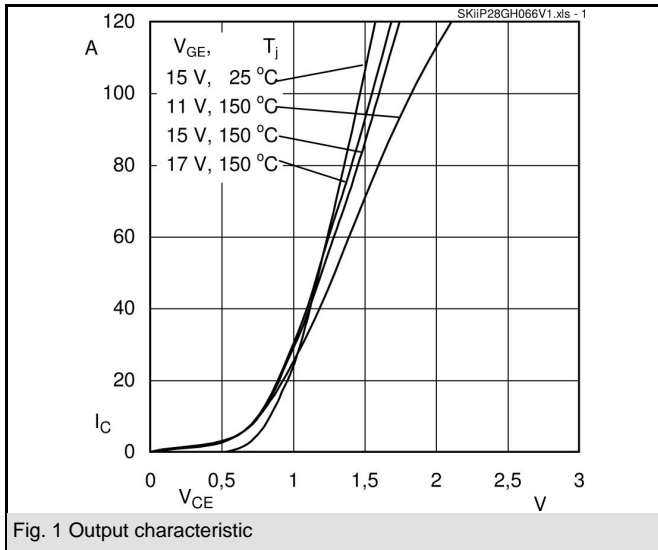
- Case temperature limited to  $T_C = 125^\circ\text{C}$
- Product reliability results are valid for  $T_j = 150^\circ\text{C}$
- SC data:  $t_p \leq 6 \mu\text{s}$ ;  $V_{GE} \leq 15 \text{ V}$ ;  $T_j = 150^\circ\text{C}$ ,  $V_{CC} = 360 \text{ V}$
- $V_{CESat}$ ,  $V_F =$  chip level value

Absolute Maximum Ratings		$T_S = 25^\circ\text{C}$ , unless otherwise specified	
Symbol	Conditions	Values	Units
<b>IGBT - Inverter</b>			
$V_{CES}$		600	V
$I_C$	$T_S = 25 (70)^\circ\text{C}$ , $T_j = 150^\circ\text{C}$	101 (68)	A
$I_C$	$T_S = 25 (70)^\circ\text{C}$ , $T_j = 175^\circ\text{C}$	112 (83)	A
$I_{CRM}$	$t_p = 1 \text{ ms}$	200	A
$V_{GES}$		$\pm 20$	V
$T_j$		-40...+175	$^\circ\text{C}$
<b>Diode - Inverter</b>			
$I_F$	$T_S = 25 (70)^\circ\text{C}$ , $T_j = 150^\circ\text{C}$	103 (67)	A
$I_F$	$T_S = 25 (70)^\circ\text{C}$ , $T_j = 175^\circ\text{C}$	112 (81)	A
$I_{FRM}$	$t_p = 1 \text{ ms}$	200	A
$T_j$		-40...+175	$^\circ\text{C}$
$I_{RMS}$	per power terminal (20 A / spring)	100	A
$T_{stg}$	$T_{op} \leq T_{stg}$	-40...+125	$^\circ\text{C}$
$V_{isol}$	AC, 1 min.	2500	V

Characteristics		$T_S = 25^\circ\text{C}$ , unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
<b>IGBT - Inverter</b>					
$V_{CESat}$	$I_{Cnom} = 100 \text{ A}$ , $T_j = 25 (150)^\circ\text{C}$	1,05	1,45 (1,65)	1,85 (2,05)	V
$V_{GE(th)}$	$V_{GE} = V_{CE}$ , $I_C = 2 \text{ mA}$		5,8		V
$V_{CE(TO)}$	$T_j = 25 (150)^\circ\text{C}$		0,9 (0,8)	1,1 (1)	V
$r_T$	$T_j = 25 (150)^\circ\text{C}$		5,5 (8,5)	7,5 (10,5)	m $\Omega$
$C_{ies}$	$V_{CE} = 25 \text{ V}$ , $V_{GE} = 0 \text{ V}$ , $f = 1 \text{ MHz}$		6,15		nF
$C_{oes}$	$V_{CE} = 25 \text{ V}$ , $V_{GE} = 0 \text{ V}$ , $f = 1 \text{ MHz}$		1,12		nF
$C_{res}$	$V_{CE} = 25 \text{ V}$ , $V_{GE} = 0 \text{ V}$ , $f = 1 \text{ MHz}$		0,9		nF
$R_{CC+EE'}$	spring contact-chip $T_S = 25 (150)^\circ\text{C}$				m $\Omega$
$R_{th(j-s)}$	per IGBT		0,6		K/W
$t_{d(on)}$	under following conditions		40		ns
$t_r$	$V_{CC} = 300 \text{ V}$ , $V_{GE} = -8\text{V}/+15\text{V}$		40		ns
$t_{d(off)}$	$I_{Cnom} = 100 \text{ A}$ , $T_j = 150^\circ\text{C}$		410		ns
$t_f$	$R_{Gon} = R_{Goff} = 8,2 \Omega$		50		ns
$E_{on}(E_{off})$	inductive load		3,4 (3,5)		mJ
<b>Diode - Inverter</b>					
$V_F = V_{EC}$	$I_{Fnom} = 100 \text{ A}$ , $T_j = 25 (150)^\circ\text{C}$		1,3 (1,3)	1,5 (1,5)	V
$V_{(TO)}$	$T_j = 25 (150)^\circ\text{C}$		0,9 (0,8)	1 (0,9)	V
$r_T$	$T_j = 25 (150)^\circ\text{C}$		4 (5)	5 (6)	m $\Omega$
$R_{th(j-s)}$	per diode		0,8		K/W
$I_{RRM}$	under following conditions		102		A
$Q_{rr}$	$I_{Fnom} = 100 \text{ A}$ , $V_R = 300 \text{ V}$		15,5		$\mu\text{C}$
$E_{rr}$	$V_{GE} = 0 \text{ V}$ , $T_j = 150^\circ\text{C}$		3,3		mJ
	$di_F/dt = 2560 \text{ A}/\mu\text{s}$				
<b>Temperature Sensor</b>					
$R_{ts}$	3 %, $T_r = 25 (100)^\circ\text{C}$		1000(1670)		$\Omega$
<b>Mechanical Data</b>					
m			65		g
$M_s$	Mounting torque	2		2,5	Nm



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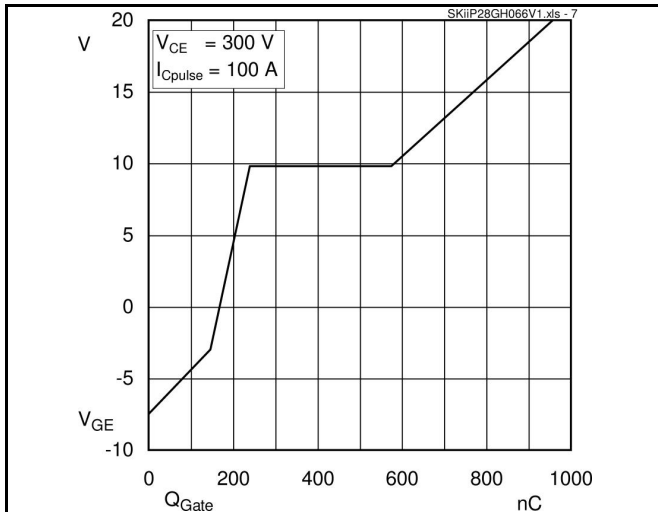


Fig. 7 Typ. Gate charge characteristic

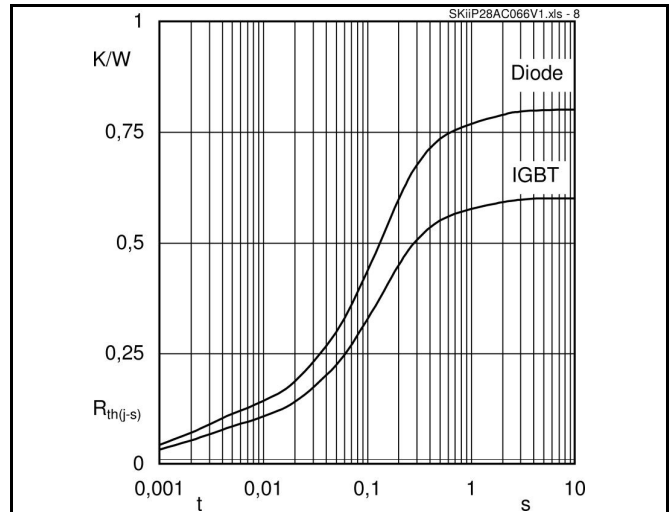


Fig. 8 Thermal impedance

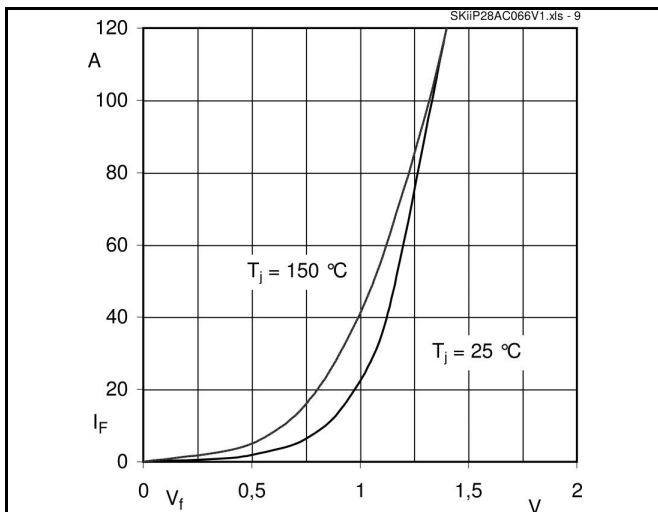
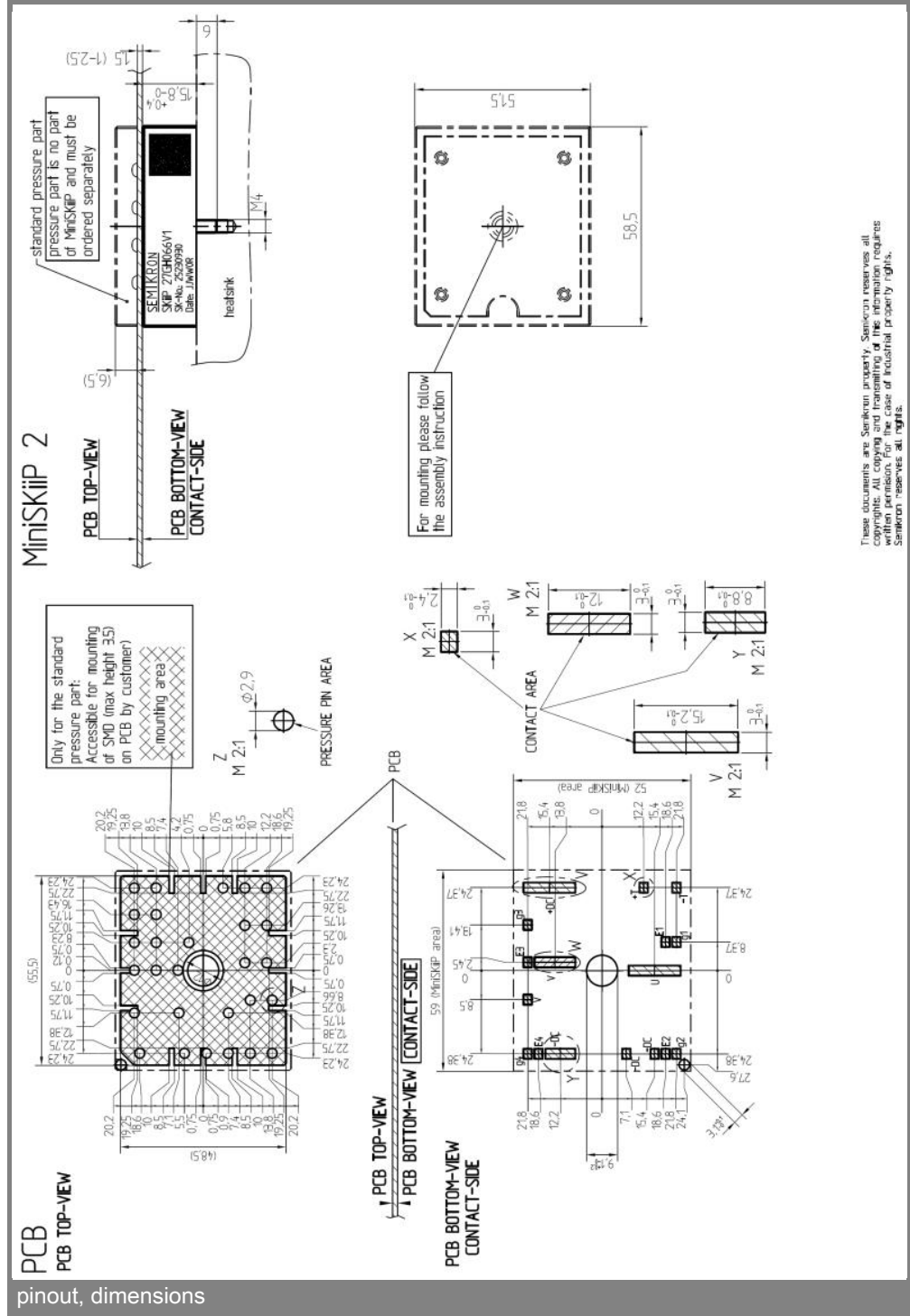
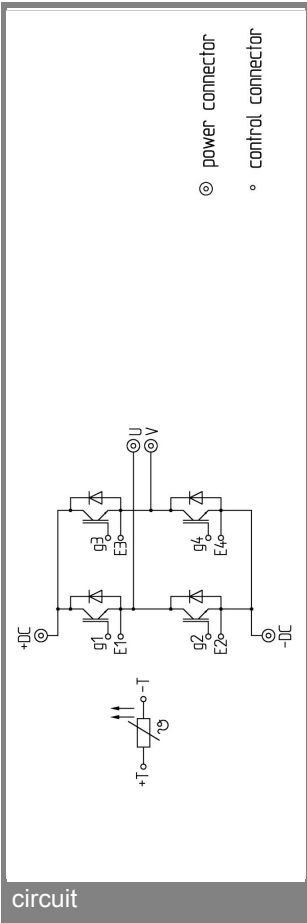


Fig. 9 Freewheeling diode forward characteristic



This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

\* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.